

### **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.									
Characteristic	Symbol	RS2 A/AA	RS2 B/BA	RS2 D/DA	RS2 G/GA	RS2 J/JA	RS2 K/KA	RS2 M/MA	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 4)	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T <sub>T</sub> = 120°C	lo				1.5				А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>				50				А

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 5)	$R_{\theta JT}$	20	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +150	°C

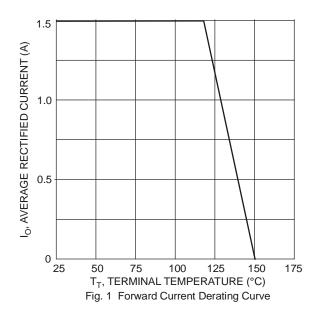
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

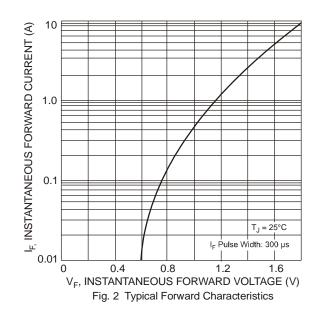
Characteristic		Symbol	RS2 A/AA	RS2 B/BA	RS2 D/DA	RS2 G/GA	RS2 J/JA	RS2 K/KA	RS2 M/MA	Unit
Forward Voltage	@ I <sub>F</sub> = 1.5A	V <sub>FM</sub>				1.3				V
Peak Reverse Current	@ $T_A = 25^{\circ}C$	la				5.0				A
at Rated DC Blocking Voltage (Note 4)	@ T <sub>A</sub> = 125°C	IRM				200				μA
Reverse Recovery Time (Note 6)		t <sub>rr</sub>		15	50		250	50	00	ns
Typical Total Capacitance (Note 7)		CT				30				pF

4. Short duration pulse test used to minimize self-heating effect. Notes:

5. Reverse recovery test conditions:  $I_F = 0.5A$ ,  $I_R = 1.0A$ ,  $I_r = 0.25A$ . See Figure 5. 6. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm<sup>2</sup> (0.013 mm thick) copper pads as heat sink.

7. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.







# RS2A/A - RS2M/A

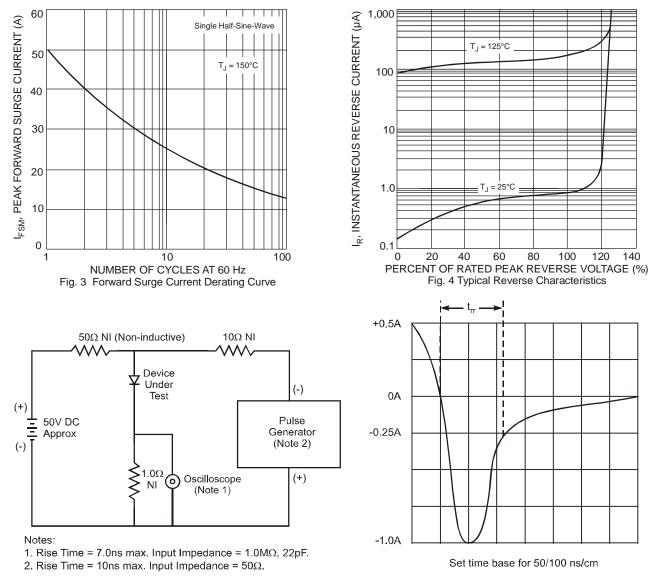
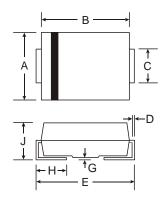


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

## **Package Outline Dimensions**

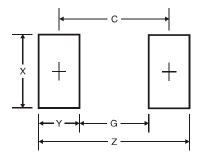


SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
C	1.27	1.63		
D	0.15	0.31		
ш	4.80	5.59		
G	0.05	0.20		
H	0.76	1.52		
<b>ر</b>	2.01	2.30		
All Dimensions in mm				

	SMB		
Dim	Min	Max	
Α	3.30	3.94	
В	4.06	4.57	
С	1.96	2.21	
D	0.15	0.31	
Е	5.00	5.59	
G	0.05	0.20	
Н	0.76	1.52	
J	2.00	2.50	
All Dimensions in mm			



### Suggested Pad Layout



SMA Dimensions	Value (in mm)
Z	6.5
G	1.5
Х	1.7
Y	2.5
С	4.0

SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Y	2.5
С	4.3

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